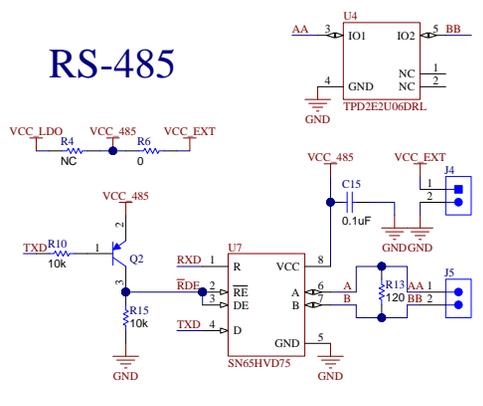
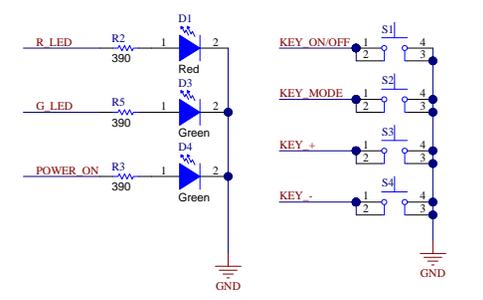
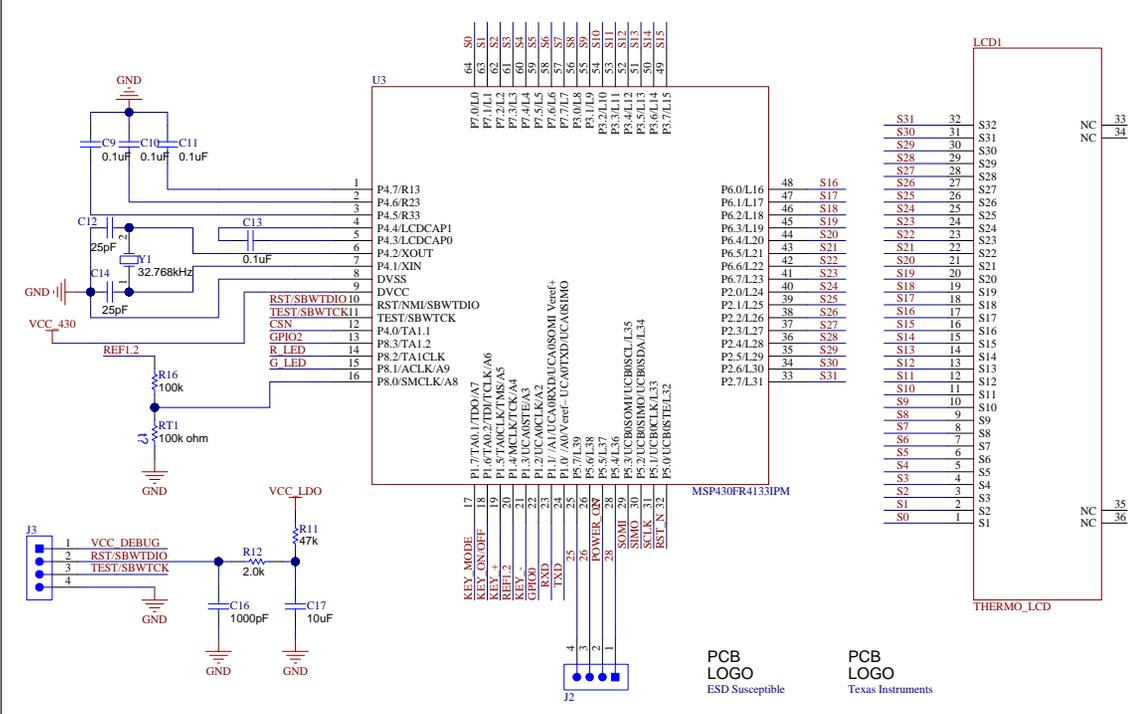
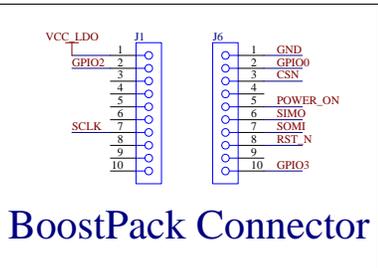
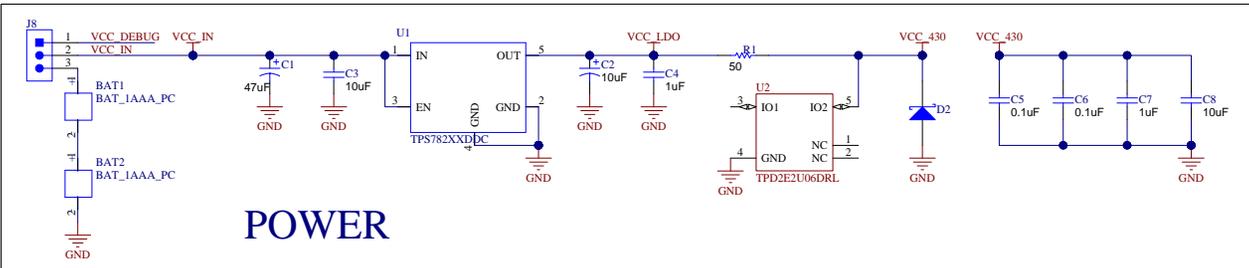


TI Designs: <TIDM-FRAM-THERMOSTAT>



PCB LOGO
ESD Susceptible
Texas Instruments

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